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AS3729B

8A Power Stage

General Description

The AS3729B is a companion power stage, intended to be used with AS372x products.

It cannot be used without a DC/DC controller. It contains the power FETs for 2 phases and is capable to handle output currents of 4A per phase.

Ordering Information and Content Guide appear at end of datasheet.

Key Benefits & Features

The benefits and features of AS3729B, 8A Power Stage are listed below:

Figure 1: Added Value of Using AS3729B

Benefits	Features
Support for single or dual phase operation	2 phases with separate control input
• 2 x 4A output stages are running up to 2.7MHz	 Separate power NMOS & PMOS for 4A per phase Separate coil current feedback per phase Stand-Alone zero-crossing operation
Over-temperature protection	Integrated temperature monitoring
Cost effective, small package	WL-CSP16: 1.615mm x 1.615mm, 0.4mm pitch

Applications

This device is a high current dual-phase DC/DC and ideal for:

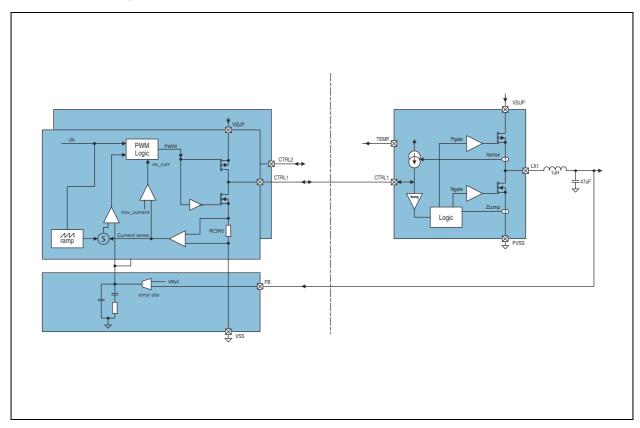
- Mobile phones
- Tablets
- Notebooks



Block Diagram

The functional blocks of this device are shown below:

Figure 2: AS3729B Block Diagram



AS3729B Block Diagram: This figure shows the block diagram of the DC/DC controller inside the Main PMIC and the AS3729B Power Stage with all relevant system components.

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Pin Assignment

Figure 3: 16 Balls WL-CSP with 0.4mm Pitch

Pin Assignments: Shows the top view pin assignment of the AS3729B

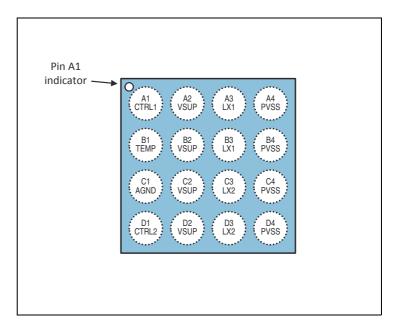


Figure 4: Pin Description

Pin Number	Pin Name	Description
A1	CTRL1	Control IO for phase 1
B1	TEMP	On/Off control and temperature feedback
C1	AGND	Analog ground
D1	CTRL2	Control IO for phase 2
A2, B2	VSUP	Phase 1 positive supply terminal
C2, D2	VSUP	Phase 2 positive supply terminal
A3, B3	LX1	Phase 1 switching output to coil
C3, D3	LX2	Phase 2 switching output to coil
A4, B4	PVSS	Phase 1 negative supply terminal
C4, D4	PVSS	Phase 2 negative supply terminal

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Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Electrical Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5:
Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Units	Comments			
	Electrical Parameters							
Supply voltage to ground 5V pins -0.5 7.0 V Applicable for pins VSUPx, LXx, CTRLx								
	Supply voltage to ground 3V pins	-0.5	5.0	V	Applicable for pin TEMP			
	Voltage difference between ground terminals	-0.5	0.5	V	Applicable for pins PVSS, AGND			
	Input current (latch-up immunity)	-100	100	mA	Norm: JEDEC JESD78			
	Continuous Po	wer Dis	sipation	(T _A = 70°C	()			
P _T	Continuous power dissipation		1	W	$P_T^{(1)}$ for WL-CSP16 package $(R_{THJA} \sim 55 K/W)$			
	Electrostatic Discharge							
ESD _{HBM} Electrostatic discharge HBM ±2 kV		kV	Norm: JEDEC JESD22-A114F					

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Symbol	Parameter	Min	Max	Units	Comments			
	Temperature Ranges and Storage Conditions							
T _A	Operating temperature	-40	85	°C				
R _{THJA}	Junction to ambient thermal resistance			°C/W	R _{THJA} typ. 55K/W			
T _J	Junction temperature		125	°C				
T _{STRG}	Storage temperature range	-55	125	°C				
T _{BODY}	Package body temperature		260	°C	Norm IPC/JEDEC J-STD-020 (2)			
RH _{NC}	Relative humidity (non condensing)	5	85	%				
MSL	Moisture sensitivity level	1			Represents an unlimited floor life time			

Note(s) and/or Footnote(s):

- 1. Depending on actual PCB layout and PCB used
- $2. The reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity" and the reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity" and the reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity" and the reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity" and the reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity" and the reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 \, "Moisture/Reflow Sensitivity (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperature) is specified according to the reflow peak soldering temperature (body temperat$ Classification for Nonhermetic Solid State Surface Mount Devices"

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Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 6: **Electrical Characteristics**

Symbol	Parameter	Note	Min	Тур	Max	Unit
		Pin VSUPx	2.5		5.5	V
V _{IN}	Input voltage	Pin CTRLx	0		5.5	V
		Pin TEMP	0		3.6	V
I _{LIMIT}	Peak coil current limit	Single phase			4.8	Α
I _{LOAD}	Load current	Continuous load current	0		3	А
	single phase	Peak load current			4 (1)	
R _{PMOS}	P-switch ON resistance (2)	Single phase		40	70	mΩ
R _{NMOS}	N-switch ON resistance (2)	Single phase		20	35	mΩ
f _{sw}	Switching frequency	Supplied by DC/DC controller		1.3	3	MHz
I _{Q_force_} PWM	Quiescent current PWM	TEMP pin high, force PWM mode active		6.2		mA
I _{Q_low_power}	Quiescent current LP	TEMP pin high, low power mode active		21		μΑ
I _{power_off}	Power-Off current	No current into pin TEMP		±1		μΑ
R _{discharge}	Active discharge	Single phase		16		Ω

Electrical Characteristics: Shows the Electrical Characteristics of the Step Down DC/DC Power Stage. VSUP = 3.8V, $T_A = 25$ °C (unless otherwise specified)

Note(s) and/or Footnote(s):

- 1. Maximum value only for pulsed peak current
- 2. MOS transistor only without package parasitic

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Typical Operating Characteristics

AS3729B Step Down DC/DC: Shows the Efficiency of AS3729B of various coil types in a 2016 package in dual and combined mode. For the dual mode two 1uH coils are used and for the combined mode one 470nH coil. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation, $T_A = 25^{\circ}C$

Figure 7: Efficiency vs. Output Current for 2016 Coil Types

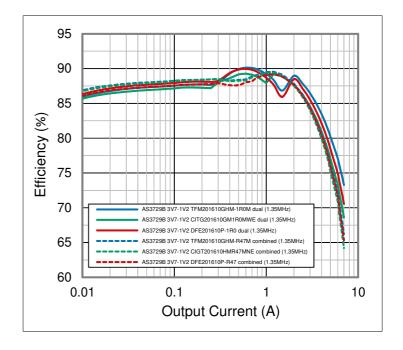
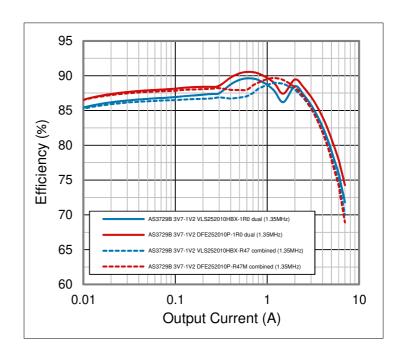


Figure 8: Efficiency vs. Output Current for 2520 Coil Types

AS3729B Step Down DC/DC: Shows the Efficiency of AS3729B of various coil types in a 2520 package in dual and combined mode. For the dual mode two 1uH coils are used and for the combined mode one 470nH coil. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation, $T_A = 25^{\circ}C$



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AS3729B Step Down DC/DC: Shows the Efficiency of AS3729B of various TDK coils in dual and combined mode. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation, $T_A = 25$ °C

Figure 9: Efficiency vs. Output Current for Various TDK Coils

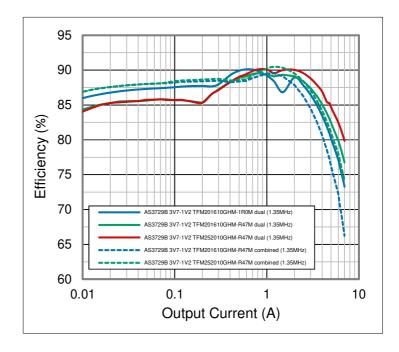
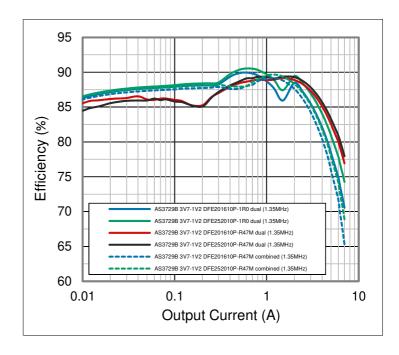


Figure 10: Efficiency vs. Output Current for Various Toko Coils

AS3729B Step Down DC/DC: Shows the Efficiency of AS3729B of various Toko coils in dual and combined mode. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation, $T_A = 25$ °C

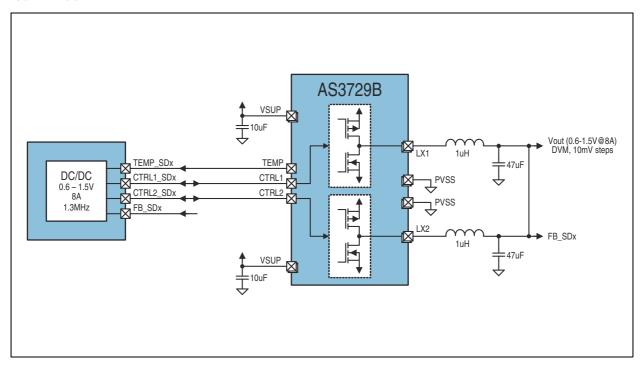


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Application Information

Figure 11: Typical Application Circuit



AS3729B Typical Application: This figure shows the connection of the DC/DC controller and the AS3729B Power Stage.

External Components

Figure 12: Step Down DC/DC Power Stage External Components

Symbol	Parameter	Note	Min	Тур	Max	Unit
	Exte	rnal Components per Phase				
C _{FB} Output Capacitor	Ceramic X5R or X7R, high performance	64	82		μF	
- C+R	Output Capacitor	Ceramic X5R or X7R, cost optimized	32	47		μF
C _{VSUP}	Input Capacitor	Ceramic X5R or X7R	6	10		μF
L	Inductor	5A rated, 1.3MHz operation, low R _{ON}	0.5	1		μΗ

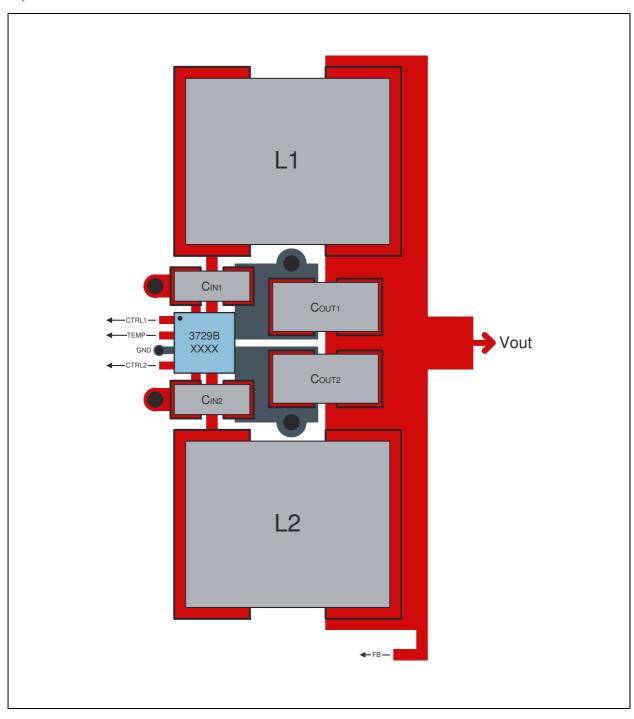
External Components: Shows the recommended values of the needed external components of the Step Down DC/DC Power Stage

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PCB Layout

Figure 13: Layout Guidelines



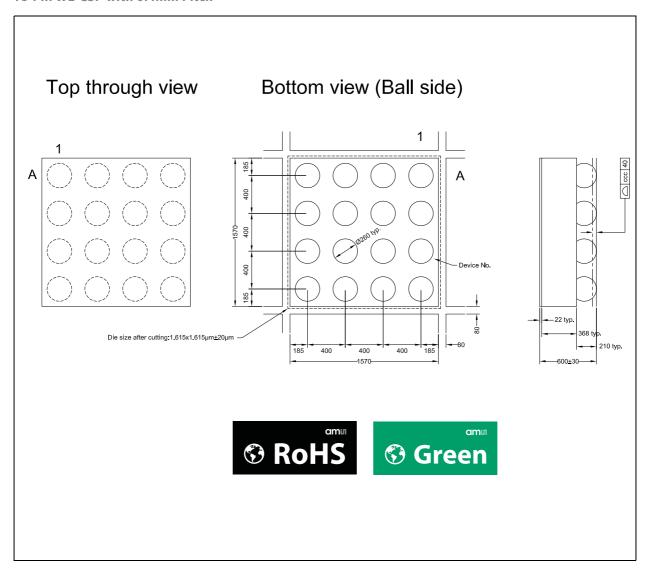
Layout Guidelines: This figure shows the recommended layout and placement of the external components for the 2-phase AS3729B Power Stage

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Package Drawings & Markings

Figure 14: 16-Pin WL-CSP with 0.4mm Pitch



Note(s) and/or Footnote(s):

- 1. Pin 1= A1
- 2. ccc coplanarity
- 3. All dimensions in μm

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Figure 15: 16-Pin WL-CPS Marking

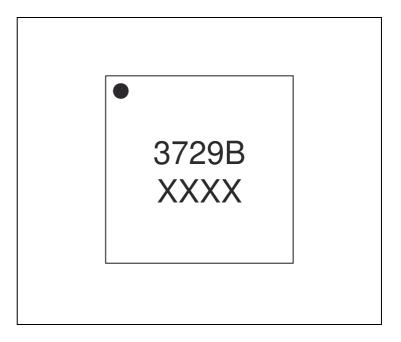


Figure 16: Packaging Code

XXXX	
Tracecode	

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Ordering & Contact Information

Figure 17: **Ordering Information**

Ordering Code	Package	Marking	Delivery Form	Delivery Quantity
AS3729B-BWLM	16-pin WL-CSP	3729B	Tape & Reel	500 pcs/reel
AS3729B-BWLT	10-βIII WL-C3F	37270	Tape & Neel	12000 pcs/reel

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Document Status	Product Status	Definition
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Revision Information

Changes from 1-01 (2014-Mar) to current revision 1-03 (2015-Sep-28)	Page			
1-01 (2014-Mar) to 1-02 (2015-Sep-21)				
Content was updated to the latest ams design				
Updated Figure 16	12			
Updated Figure 17	13			
1-02 (2015-Sep-21) to 1-03 (2015-Sep-28)				
Updated Figure 14	11			

Note(s) and/or Footnote(s):

- 1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- 2. Correction of typographical errors is not explicitly mentioned.

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